

● General Description

The AGM70N07C combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$.

This device is ideal for load switch and battery protection applications.

● Features

- Advance high cell density Trench technology
- Low $R_{DS(ON)}$ to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

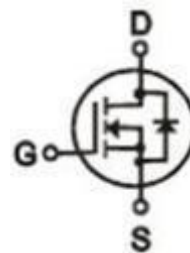
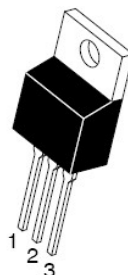
● Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Product Summary

BVDSS	RDSON	ID
70V	8.8mΩ	70A

TO-220 Pin Configuration



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM70N07C	AGM70N07C	TO-220C	----	----	1000

Table 1. Absolute Maximum Ratings (TA=25°C)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	70	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25°C) (Note 1)	70	A
	Drain Current-Continuous(Tc=100°C)	--	A
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 2)	--	A
PD	Maximum Power Dissipation(Tc=25°C)	--	w
	Maximum Power Dissipation(Tc=100°C)	--	w
EAS	Avalanche energy (Note 3)	100	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) ¹	---	--	°C/W
RθJC	Thermal Resistance Junction-Case ¹	---	--	°C/W

Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250μA	70	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=48V,VGS=0V	--	--	1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	2.2	3.0	3.8	V
gFS	Forward Transconductance	VDS=5V,ID=20A	--	--	--	S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=10A	--	8.8	14	mΩ
		VGS=4.5V, ID=5A	--	--	--	mΩ
Dynamic Characteristics						
Ciss	Input Capacitance	VDS=30V,VGS=0V, F=1MHZ	--	3000	--	pF
Coss	Output Capacitance		--	170	--	pF
Crss	Reverse Transfer Capacitance		--	140	--	pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz	--	1.6	--	Ω
Switching Times						
td(on)	Turn-on Delay Time	VGS=10V,VDS=30V, ID=30A,RGEN=3Ω	--	49	--	nS
tr	Turn-on Rise Time		--	230	--	nS
td(off)	Turn-Off Delay Time		--	65	--	nS
tf	Turn-Off Fall Time		--	110	--	nS
Qg	Total Gate Charge	VGS=10V, VDS=48V, ID=30A	--	56	--	nC
Qgs	Gate-Source Charge		--	18	--	nC
Qgd	Gate-Drain Charge		--	16	--	nC
Source-Drain Diode Characteristics						
ISD	Source-Drain Current(Body Diode)		--	--	70	A
VSD	Forward on Voltage	VGS=0V,IS=10A	--	0.99	1.3	V
trr	Reverse Recovery Time	IF=10A , dl/dt=500A/μs , TJ=25℃	--	--	--	ns
Qrr	Reverse Recovery Charge		--	--	--	nc

Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25°C

Characteristics Curves (25°C)

Figure 1 Output characteristics

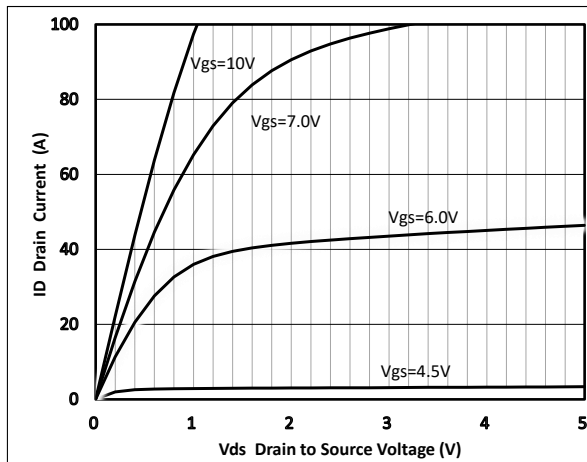


Figure 2 Transfer Characteristics

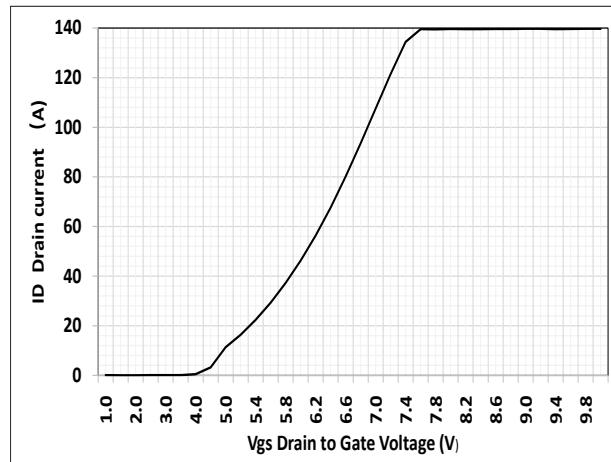


Figure 3 On-Resistance vs Id

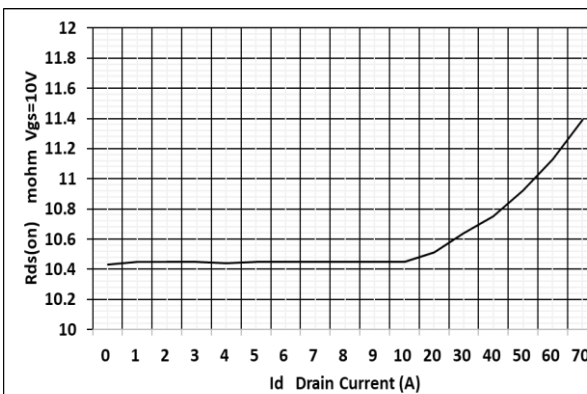


Figure 4 On-Resistance vs Vgs

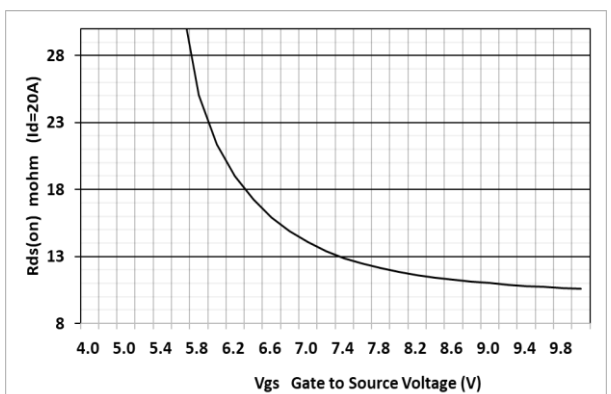


Figure 5 Body Diode Forward Voltage

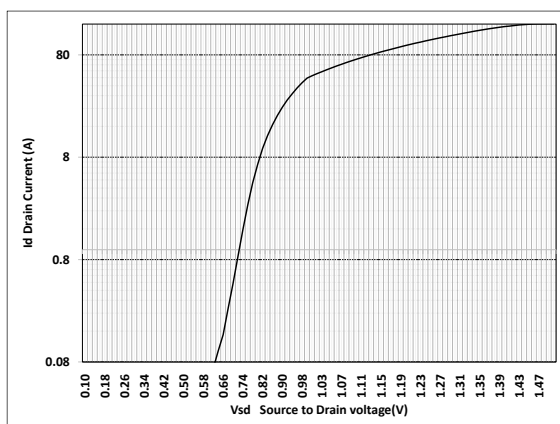
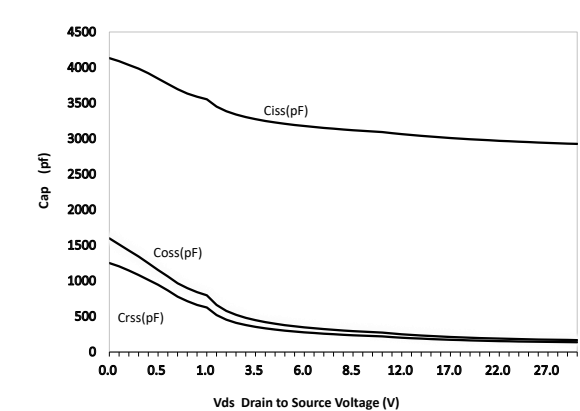
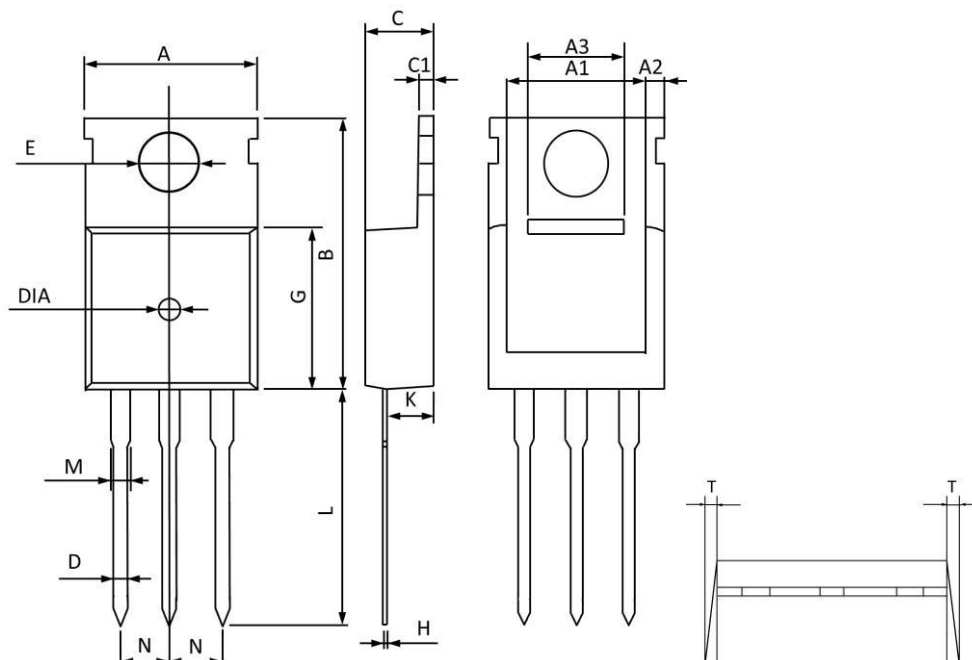


Figure 6 Capacitance Characteristics



TO220 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	10.300	9.700	0.406	0.382
A1	8.840	8.440	0.348	0.332
A2	1.250	1.050	0.049	0.041
A3	5.300	5.100	0.209	0.201
B	16.200	15.400	0.638	0.606
C	4.680	4.280	0.184	0.169
C1	1.500	1.100	0.059	0.043
D	1.000	0.600	0.039	0.024
E	3.800	3.400	0.150	0.134
G	9.300	8.700	0.366	0.343
H	0.600	0.400	0.024	0.016
K	2.700	2.100	0.106	0.083
L	13.600	12.800	0.535	0.504
M	1.500	1.100	0.059	0.043
N	2.590	2.490	0.102	0.098
T	W0.35		W0.014	
DIA	Φ1.5 TYP.	deep0.2 TYP.	Φ0.059 TYP.	deep0.008 TYP.

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